HTE301

Digital Humidity and Temperature Sensor

The HTE301 is the next generation of the digital RH/T series HTEx01. The sensor provides an accuracy of up to 1.8 %RH incl. hysteresis, a constant current heater and integrated sensor coating. With a 16-bit unsigned integer value and a different pin assignment compared to HTE501, the HTE301 allows an easy upgrade for your existing application with minimal integration effort.

Furthermore the sensor covers a wide application range from -40 to +125 $^{\circ}$ C and 0 to 100 $^{\circ}$ RH. Therefore, the HTE301 offers a versatile measuring device for demanding tasks. With a footprint of only 2.5 x 2.5 mm and the expansion of up to 4 I²C addresses, it ensures an outstanding performance at an excellent price-performance ratio.



Key Features.

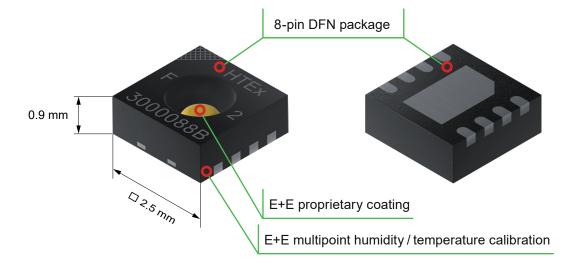
- Accuracy: up to ±1.8 %RH (incl. hysteresis) up to ±0.2 °C
- E+E proprietary coating
- Supply voltage 2.35 3.60 V
- 8-pin DFN package
- Constant current heater

- I²C interface with pin-selectable addresses
- I²C glitch suppression
- Relative humidity hysteresis compensation
- Excellent repeatability

Typical Applications

- Building automation
- Consumer electronics
- Home appliances
- Industrial automation

- Medical devices
- Smart home
- Wearable devices
- White goods





CONTENTS

Int	roduc	tion to the E+E Digital Humidity and Temperature Sensor	1
1	Pin (Configuration	5
2	Турі	cal Application	5
3	Spec	cifications	6
	3.1	Relative Humidity Sensor	
	3.2	Temperature Sensor	6
	3.3	Recommended Operating Conditions	7
4	Elec	trical Characteristics	8
	4.1	Absolute Maximum Ratings	8
	4.2	Electrical Specification	8
5	Inter	rface	10
	5.1	Pin Configuration, Assignment and Description	10
	5.2	Supply Pins (V _{DD} , GND)	10
	5.3	I ² C Communication	10
	5.4	I ² C Address Pins	11
	5.5	ALERT Pin (3)	11
	5.6	Reset Pin (6)	12
6	Sens	sor Communication	13
	6.1	Command Overview	
	6.2	Measured Data Format	13
	6.3	Measurement Modes	
	6.4	Single Shot Measurement	
	6.5	Periodic Measurement	
	6.6	Fetch Periodic RH&T Measurement Results (0xE000)	
	6.7	Break Command (0x3093)	
	6.8	Reset Commands (0x30A2, 0x06)	
	6.9	Status Register (0xF32D, 0xF352, 0x3041)	
	6.10	Constant Current Heater (0x306D, 0x3066)	
	6.11	CRC Calculation	
	6.12	3	
		Traceshility	
		Traceability	
	6.15	Ordering Information Recommended Layout	
_		•	
7		lity	
8	Addi	itional Documentation	23
9	Revi	ision History	23



LIST OF FIGURES

Figure 1: [DFN8 pin configuration	5
Figure 2: 1	Typical application schematic	5
Figure 3: 1	Humidity measurement accuracy @ 25 °C (incl. hysteresis)	6
Figure 4: 1	Femperature sensor accuracy	7
Figure 5: (Operating conditions	7
Figure 6: S	Sensor behaviour at power-up	10
Figure 7: I	/O input reset pin behavior versus the V _{DD} voltage	12
Figure 8: S	Single shot measurement	14
Figure 9: F	Periodic measurement	14
Figure 10:	Start single-shot measurement readout	15
Figure 11:	Clock stretching during measurement	15
Figure 12:	Poll for meauring values until ACK	15
Figure 13:	Measured value readout	15
Figure 14:	Periodic measurement commands	16
Figure 15:	Fetch command	17
Figure 16:	Break command	17
Figure 17:	Soft reset	17
Figure 18:	Reset through general call	18
Figure 19:	Read out status register	18
Figure 20:	Clear status register	18
Figure 21:	Constant current heater commands	20
Figure 22:	CRC8 properties.	20
Figure 23:	Package layout	21
Figure 24:	Tape layout	21
Figure 25:	Orientation on the tape	22
Figure 26:	HTEx laser marking	22
Figure 27:	Recommended land pattern and stencil aperture	23



LIST OF TABLES

Table 1: List of HTEx specific acronyms	4
Table 2: HTE301 pin assignment	5
Table 3: Relative humidity sensor	6
Table 4: Temperature sensor parameters	6
Table 5: HTE301 absolute maximum ratings	8
Table 6: General operation	8
Table 7: I ² C communication pins SCL & SDA	9
Table 8: I/O pins	9
Table 9: General timing	9
Table 10: Measurement resolution	10
Table 11: HTE301 commands	13
Table 12: Status Register	19
Table 13: Package dimensions	21
Table 14: Applicable documentation	23
Table 15: Revision history	23

ACRONYM	MEANING
Α	Ambient
В	Bus
CDM	Charged Device Model
ESD	Electrostatic Discharge
HBM	Human Body Model
MEAS	Measurement, Measuring
PORI	Power On Reset, Idle Mode
PORP	Power On Reset, Periodic Mode
POR	Power On Reset
PU	Pull-up
PUPE	Pull-up external
PUPI	Pull-up internal
PWRU	Power Up
Т	Temperature

Table 1: List of HTEx specific acronyms

1 Pin Configuration

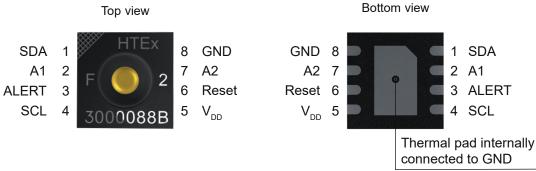


Figure 1: DFN8 pin configuration

PIN#	NAME	PIN TYPE	DESCRIPTION
1	SDA	I/O	Serial data line for I^2C communication. The external pull-up resistors (e.g. $R_p = 4.7 \text{ k}\Omega$) are required to pull the signal high.
2	A1	Input high-Z	I ² C device address pin; bit 1 of the 7 bit address; do not leave floating, to be connected to the GND for default I ² C address.
3	ALERT	Output push-pull	Indicates alarm condition; leave floating if unused.
4	SCL	I/O	Serial clock line for I^2C communication. The external pull-up resistors (e.g. R_p = 4.7 k Ω) are required to pull the signal high.
5	V_{DD}	Power	Positive supply pin
6	Reset	Inverted input with pull-up	Reset pin active low; leave floating if unused; can be connected to V_{DD} with a series resistor of $R \ge 2 \ k\Omega$.
7	A2	Input high-Z	I ² C device address pin, bit 2 of the 7 bit address; do not leave floating, to be connected to the GND for default I ² C address.
8	GND	Power	Ground (internally connected to thermal pad) ¹⁾

¹⁾ Soldering of the thermal pad is optional. However, the soldering is recommended. Do not use the heat conduction pad on the PCB for heat dissipation but purely as a mounting surface, otherwise heating energy is lost.

Table 2: HTE301 pin assignment

2 Typical Application

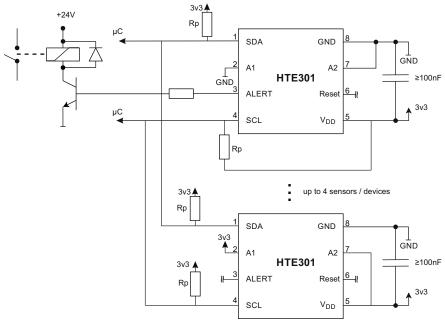


Figure 2: Typical application schematic



3 Specifications

3.1 Relative Humidity Sensor

PARAMETER	CONDITION(S)	MIN	TYP	MAX	UNITS
Operating range		0		100	%RH
Accuracy ¹⁾²⁾	Periodic mode		±1.8	See Figure 3	%RH
Hysteresis ²⁾			±0.9		%RH
Resolution ³⁾	high		0.02		%RH
Repeatability ⁴⁾	high		0.02		%RH
Response time ⁵⁾	τ_{63}		5		S
Long term drift ⁶⁾			<0.5%		%RH/yr

Table 3: Relative humidity sensor

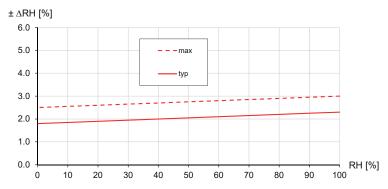


Figure 3: Humidity measurement accuracy @ 25 °C (incl. hysteresis)

3.2 Temperature Sensor

PARAMETER	CONDITION	MIN	TYP	MAX	UNIT
Operating Range ⁷⁾	Heater OFF	-40		125	°C
Accuracy			0.2	See Figure 4	°C
Resolution ⁸⁾	high		0.01		°C
Repeatability ⁴⁾	high		0.03		°C
Response time ⁹⁾	τ_{63}	2			S
Long Term Drift			<0.03		°C/yr

Table 4: Temperature sensor parameters

¹⁾ In the periodic mode the humidity hysteresis is included. See also chapter 3.3 Recommended Operating Conditions.

²⁾ In the periodic mode the humidity accuracy is within the hysteresis. In the single shot measurement, the humidity hysteresis must be added to the given humidity accuracy to obtain the overall accuracy.

³⁾ Resolution is chosen by the corresponding measurement command.

⁴⁾ The stated "Noise / Repeatability" is 3 times the standard deviation (3σ) of multiple consecutive measurement values at constant environmental conditions.

⁵⁾ Time for achieving 63 % of a step function, valid at 25°C and 1 m/s airflow.

The actual response time in application strongly depends on the surrounding of the sensor in the final application (heat conductivity of sensor substrate, dead volume....).

⁶⁾ Value may be higher in environments with vaporized solvents, out-gassing tapes, adhesives, packaging materials, etc. For more details please refer to the HTE301 Handling Instructions.

⁷⁾ With the "Heater ON" take care that the sensor temperature does not get higher than the maximum allowed temperature

⁸⁾ Resolution is chosen by the corresponding measurement command.

⁹⁾ Time for achieving 63 % of a step function, valid at 25 °C and 1m/s airflow.

The actual response time in application strongly depends on the surrounding of the sensor in the final application (heat conductivity of sensor substrate, dead volume, ...).

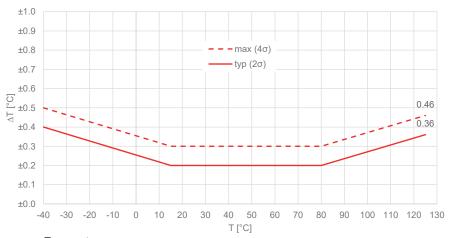


Figure 4: Temperature sensor accuracy

3.3 **Recommended Operating Conditions**

Humidity and temperature:

The sensor shows best performance when operated within the normal operating conditions (dark green area in Figure 5). This means 20...80 %RH and temperature >0 °C.

Exposure conditions outside this "Normal operating condition" for a long time, especially at high humidity >80 %RH may cause a temporary humidity gain error. If the sensor is brought back to normal operating conditions, the initial values will recover. Applications with high humidity at high temperatures will result in slower recovery. Reconditioning procedures can accelerate the recovery process.

Although the sensors would not fail beyond the normal operating condition limits, the specification is guaranteed within the "Normal operating condition" or within the "Extended operating conditions" (light green area) after a reconditioning procedure.

Prolonged exposure to extreme operating conditions (marked orange in Figure 5) may accelerate ageing.

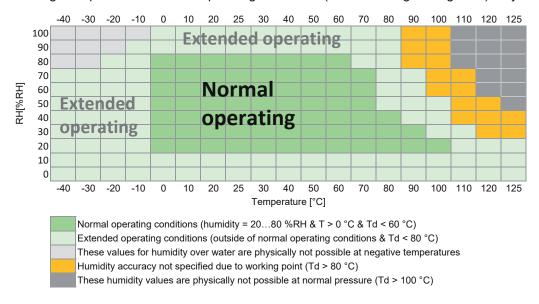


Figure 5: Operating conditions



4 Electrical Characteristics

4.1 Absolute Maximum Ratings

The absolute maximum ratings as given in Table 5 are stress ratings only and give additional information. Functional operation of the device at these conditions is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability (e.g. hot carrier degradation, oxide breakdown).

PARAMETER	SYMBOL	MIN	MAX	UNIT
Power supply	V_{DD}	-0.3	3.6	V
Digital input pins (without pull-up)	V _{LOGIC}	-0.3	5.0	V
Input current on any pin	I _{IN}	-50	50	mA
Storage temperature	T _{STG}	-55	150	°C
ESD HBM¹)	ESD _{HBM}	-	4	kV
ESD CDM ²⁾	ESD _{CDM}	-	750	V

¹⁾ Human Body Model according to AEC-Q100-002

Table 5: HTE301 absolute maximum ratings

4.2 Electrical Specification

Typical values correspond to V_{DD} = 3.3 V and T_A = 25 °C.

Min. and max. values are valid in the full temperature range -40 $^{\circ}$ C ... 125 $^{\circ}$ C and at declared V_{DD} levels, unless otherwise noted.

PARAMETER	SYMBOL	CONDITION / COMMENT	MIN	TYP	MAX	UNIT
Supply Voltage	V_{DD}		2.35	3.3	3.6	V
POR voltage periodic mode	V_{PORP}	Static power supply	2.10	2.20	2.35	V
POR voltage idle mode	V _{PORI}	Static power supply		1.8		V
		Single mode (idle) ¹⁾		6		μΑ
		Periodic mode ¹⁾		80		μA
Supply current	I _{DD}	Measuring T, RH, Calculation		900		μA
		Constant current heater ²⁾		5		mA
Thermal resistance	R _{TH}	Dependent on PCB layout and enviromental conditions		150		K/W

¹⁾ Without I²C communication and when not measuring

Table 6: General operation

²⁾ Charged Device Model according to AEC-Q100-011

²⁾ The chip temperature must not exceed 125°C with heater on.



PARAMETER	SYMBOL	CONDITION / COMMENT	MIN	TYP	MAX	UNIT
lanut valtana	V _{IL}	Low level			0.3*V _{DD}	V
Input voltage	V _{IH}	High level	0.7*V _{DD}		V_{DD}	V
Output voltage	V _{OL}	Current into pin: I _{OL} = 4.0 mA	0	0.25	0.40	V
Output voltage	V _{OH}	High level → open drain				
	D	V_{DD} =3.60 V & pin voltage = 0.7* V_{DD}		25		kΩ
Internal pull-up		V_{DD} =3.30 V & pin voltage = 0.7* V_{DD}		27		kΩ
resistor	R _{PUPI}	V_{DD} =3.00 V & pin voltage = 0.7* V_{DD}		30		kΩ
		V_{DD} =2.35 V & pin voltage = 0.7* V_{DD}		34		kΩ
External pull-up resistor	R _{PUPE}	At I ² C lines, pull-up current ≤4.0 mA @ 3.3 V	0.725	4.7		kΩ
		Standard			400	pF
Capacitive bus load	C _B	Fast mode			400	pF
		Fast mode plus			177	pF

¹⁾ Characterized but not tested.

Table 7: I²C communication pins SCL & SDA

PARAMETER	SYMBOL	CONDITION / COMMENT	MIN	TYP	MAX	UNIT
	V _{IL}	Low level			0.3*V _{DD}	V
Input voltage	V _{IH}	High level, 5 V tolerant input (without pull-up resistor)	0.7*V _{DD}	V_{DD}	5.0	V
Input leakage	I _{VDD}	Voltage @pin = 0V _{DD}	-10	0	+10	μΑ
current	I _{I5V}	Voltage @pin = V _{DD} 5 V		TBD		μA
Output resistance	R _{OH}	Voltage @pin = V _{DD} -0.4 V		116		Ω
Output resistance	R _{OL}	Voltage @pin = 0.4 V		100		Ω

Table 8: I/O pins

PARAMETER	SYMBOL	CONDITION / COMMENT	ТҮР	UNIT
Power-up time t _{PWRU}		After V _{DD} > V _{PORP} , exclude measurement at power-up	1.1	ms
Reset time	t _{RESET}	Any reset except power-up	0.9	ms
		Low repeatability	1.2	ms
T measurement	t _T	Medium repeatability	2.3	ms
		High repeatability	8.9	ms
	t _{RH}	Low repeatability	0.5	ms
RH measurement		Medium repeatability	1.0	ms
		High repeatability	4.1	ms
Measurement calculation	t _{CALC}	After each measurement	1.2	ms
SCL SDA input filter	t _{spike}	Short voltage spikes are ignored	25	ns

Table 9: General timing

Subsequently, the typical measurement time with high repeatability is $t_{MEAS} = t_T + t_{RH} + t_{CALC} = 8.9 + 4.1 + 1.2$ = 14.2 ms.



	TEMPERATURE	HUMIDITY
Repeatability	Resolution [°C]	Resolution [%RH]
High	0.01	0.02
Medium	0.06	0.09
Low	0.11	0.18

Table 10: Measurement resolution

5 Interface

5.1 Pin Configuration, Assignment and Description

Please refer to chapter 1.

5.2 Supply Pins (V_{DD}, GND)

The supply pins must be equipped with a bypass ceramic capacitor of at least 100nF.

When using the constant current heater, a current change in the heater must not lead to a voltage drop below the minimum V_{DD} value (refer to Table 6). This means the bypass capacitor needs to be dimensioned sufficiently large so that the voltage controller is supplied adequately.

Sensor Power-up

As soon as V_{DD} exceeds the POR voltage V_{PORP} , the device gets initialized. After t_{PWRU} , the initialization procedure is completed.

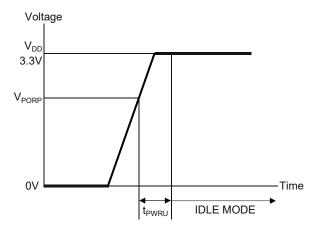


Figure 6: Sensor behaviour at power-up

5.3 I²C Communication

The I²C communication is based on the NXP UM10204 I²C bus specification and user manual¹⁾. The HTE301 supports the modes "standard" (100 kHz), "fast mode" (400 kHz) and "fast mode plus" (1 000 kHz).

The sensor works as SLAVE and needs to be queried by a MASTER.

¹⁾ Revision 6, 4 April 2014, download from https://www.nxp.com/docs/en/user-guide/UM10204.pdf.

5.4 I²C Address Pins

The sensor's I²C base address is 0x44 (without R/ bit). Pins A1...A2 define the I²C base address.

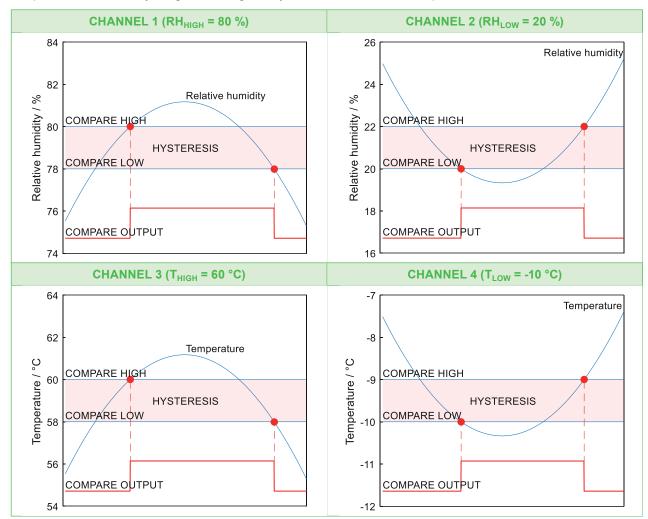
			PIN 7	PIN2		AVE Iress nifted)	AVE Iress h W)	AVE dress ith R)			
						A2	A1	R/W	SL/ Add (unsh	SLA\ Addre (with	SL, Add (wit
bit#	7	6	5	4	3	3	1	0	٥		
	1	0	0	0	1	0	0	1/0	0x44	0x88	0x89
	1	0	0	0	1	0	1	1/0	0x45	0x8A	0x8B
	1	0	0	0	1	1	0	1/0	0x46	0x8C	0x8D
	1	0	0	0	1	1	1	1/0	0x47	0x8E	0x8F

ALERT Pin (3) 5.5

The ALERT pin indicates low when the temperature and relative humidity are in the range:

- RH = [RH_{LOW}, RH_{HIGH}] = [20 %, 80 %]
 T = [T_{LOW}, T_{HIGH}] = [-10 °C, +60 °C]

If any of temperature or relative humidity measurement values goes outside this range the ALERT pin will output high, which will remain high as long as the corresponding value will go back inside the given temperature or humidity range including the hysteresis as shown in the plots below





5.6 Reset Pin (6)

As soon as the falling edge on the reset pin is in the logic "0" blue area (low signal), as shown in the diagram below, the device goes into the reset and remains in this state as along as the voltage on the reset pin remains in the logic "0" area. In particular, during this phase, the device is in the cycle of being powered-up and reset immediately after power-up, thus the current consumption corresponds to the power-up current, approximately 1 mA. During the reset time, the device will not respond to any request on the I²C interface and set all digital outputs into a tristate mode.

As soon as the voltage rising edge reaches the logic "1" green area (high signal), the devices will be powered-up properly. The default (non-reset) pin state is high (typically 3.3V). If unused, the reset pin can be connected to the V_{DD} .

Already short voltage drops (10 ns) on the reset pin will lead to the reset state. Thus, it is recommended to use an appropriate capacitor to avoid unwanted resets.

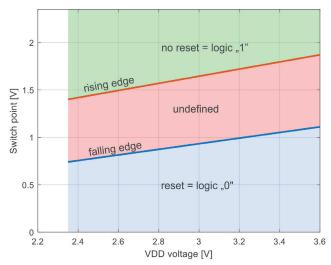


Figure 7: I/O input reset pin behavior versus the V_{DD} voltage

6 Sensor Communication

6.1 Command Overview

Measurement commands

Measurement mode	Description	CMD He	ex Code	Repeatability
	I ² C clock stretching	MSB	LSB	
	enabled		06	High
		0x2C	0D	Medium
Cinalo abot			10	Low
Single-shot			00	High
	disabled	0x24	0B	Medium
			16	Low
	Measurement interval	MSB	LSB	
			32	High
	0.5 mps	0x20	24	Medium
			2F	Low
			30	High
	1 mps	0x21	26	Medium
			2D	Low
		0x22	36	High
Periodic	2 mps		20	Medium
			2B	Low
			34	High
	4 mps	0x23	22	Medium
			29	Low
			37	High
	10 mps	0x27	21	Medium
	·		2A	Low

Table 11: HTE301 commands

Further commands

CMD Hex Code	Description
0xE000	Fetch periodic measurement data
0x30A2	Soft Reset
0x3093	Break
0x306D	Heater ON
0x3066	Heater OFF
0x3041	Clear status register
0xF32D	Readout of status register
0x06	I ² C Reset at general call address 0x0

6.2 Measured Data Format

Temperature [°C] = $-45 + 175 \cdot (Temperature MSB * 256 + Temperature LSB) / (2¹⁶-1)$

Humidity [%RH] = $100 \cdot (Humidity MSB * 256 + Humidity LSB) / (2^{16}-1)$



6.3 Measurement Modes

There are two different operation modes to communicate with the sensor:

1. Single Shot Measurement

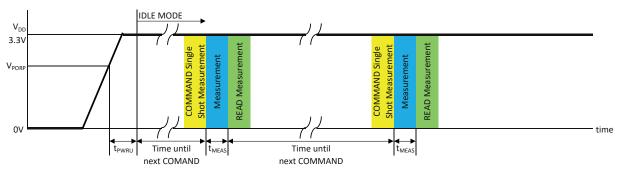


Figure 8: Single shot measurement

2. Periodic Measurement

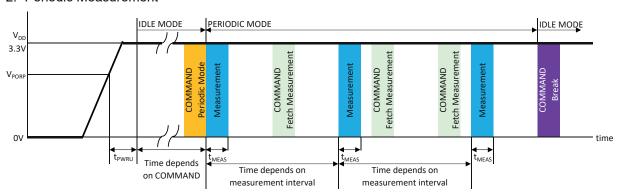


Figure 9: Periodic measurement

6.4 Single Shot Measurement

The command initiates a single measurement, the measured data is available for query after t_{MEAS} . I^2C clock stretching enabled: waiting for the end of the measurement during command execution.

Condition	CMD Hex Code		Repeatability	
I ² C clock stretching	MSB LSB		Repeatability	
		06	High	
Enabled	0x2C	0D	Medium	
		10	Low	
Disabled		00	High	
	0x24	0B	Medium	
		16	Low	

A single-shot measurement is started after the command has been received successfully. The readout of

the calculated values RH and T is started by sending the I²C address again in read mode:

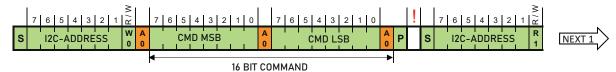


Figure 10: Start single-shot measurement readout

In case a command with clock stretching enabled has been issued, the slave holds SCL low until the calculation has been finished:



Figure 11: Clock stretching during measurement

In case a command without clock stretching has been issued, the slave does not acknowledge (NACK) a read header as long as the calculation has not been finished:

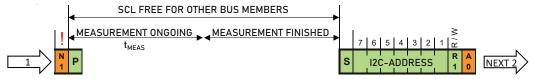


Figure 12: Poll for meauring values until ACK

After the calculation is finished, the slave responds to a read header with a pair of data words, each of them is followed by an 8 bit checksum (CRC8). The first data word contains the temperature value while the second word contains the relative humidity value. The master has to acknowledge each single data byte by an acknowledge (ACK), otherwise the slave will stop sending any further data and wait for a stop condition (P):

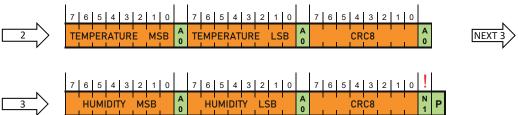
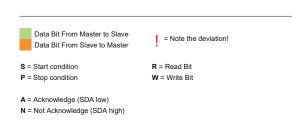


Figure 13: Measured value readout





6.5 Periodic Measurement

Once issued, measurements and calculations are started automatically with a given measuring interval and resolution.

This mode does not support clock stretching.

Condition	CMD Hex Code		Repeatability
Measurement interval	MSB	LSB	Repeatability
		32	High
0.5 mps	0x20	24	Medium
		2F	Low
		30	High
1 mps	0x21	26	Medium
		2D	Low
		36	High
2 mps	0x22	20	Medium
		2B	Low
		34	High
4 mps	0x23	22	Medium
		29	Low
		37	High
10 mps	0x27	21	Medium
		2A	Low

i

Please note: A short measurement interval can influence the power consumption and therefore the self-heating of the sensor.

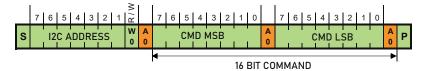


Figure 14: Periodic measurement commands

A periodic measurement command with a different measurement interval / resolution can be issued at any time, but the calculated value will be updated according the new settings earliest after a measurement with the new settings has been performed.

6.6 Fetch Periodic RH&T Measurement Results (0xE000)

Readout of calculation results in periodic measurement mode can be performed using the fetch command. This is similar to the readout of measurement results in single-shot mode, except that clock stretching is always disabled. The slave will answer with NACK if no measurement results are available.

Command	CMD Hex Code
Fetch data	0xE000

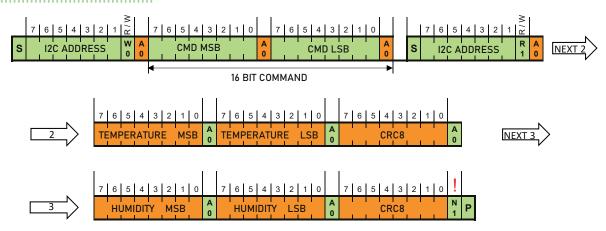


Figure 15: Fetch command

This command is also suitable for reading out the measured data generated by the power-up procedure.

6.7 Break Command (0x3093)

The periodic measurement mode can be stopped using the break command. After finishing an ongoing measurement, the sensor will enter the idle mode. An ongoing measurement can delay the transition into the idle mode.

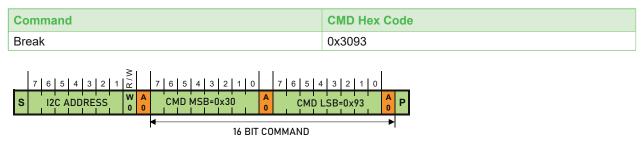


Figure 16: Break command

A single measurement (command) or a reset (command or power-up) both stop the periodic measurement, too.

6.8 Reset Commands (0x30A2, 0x06)

The slave supports multiple commands to reset the device. Once a reset command is received, the device is completely reset, like a reset during power-up. During the reset time, the device will not respond to any request on the I²C interface.

In order to execute the reset on a specific device, the command "Soft Reset" can be used. This forces the system to execute the startup procedure without the need to remove the power supply. The protection will be re-established with the "Soft Reset".

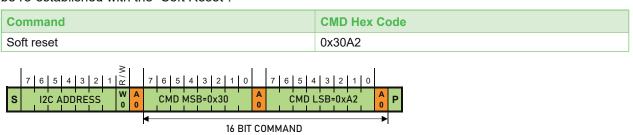


Figure 17: Soft reset



In order to reset all devices on the bus, the master can use the "General call" mode. This generates a reset (system startup) in all devices on the bus which support this function. The effect is the same as for the "Soft Reset" command.

Command	Hex Code
Address byte	0x00
Second byte	0x06

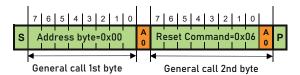


Figure 18: Reset through general call

In order to reset the I²C interface only, keep SDA high while toggling SCL nine times or more. This must be followed by a start condition preceding the next command. This sequence does not affect any configuration, status register or system status.

6.9 Status Register (0xF32D)

The sensor implements a 16 bit status register. Its contents can be read using the following commands:

Command	CMD Hex Code	
	MSB	LSB
Read out Status Register	0xF3	0x2D

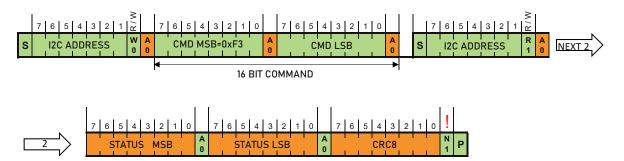
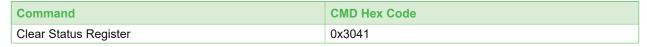


Figure 19: Read out status register

Upon receipt of the following clear command, bits 15, 4 and 3 are cleared in status register. All other bits remain unaffected:



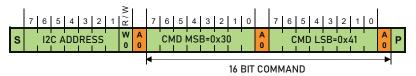


Figure 20: Clear status register

BIT	NAME	DESCRIPTION	
15	OVERALL_ERROR	0: none of bits [11:0] set 1: at least one of bits [11:0] set This bit is cleared upon the Clear Status Register command	
14	Reserved	-	
13	CONSTANT_HEATER	0: Heater OFF 1: Heater ON	
12	Reserved	-	
11	T out of RANGE		
10	RH out of RANGE		
9	RH or T out of RANGE	0: no alert 1: alert (see ALERT pin)	
8	T < T _{LOW}	1 /	
7	T > T _{HIGH}	These bits are cleared upon "Clear status register" command	
6	RH < RH _{LOW}		
5	RH > RH _{HIGH}		
4	System Reset	o: no reset since status 1 clear POR or I ² C reset This bit is cleared upon the Clear Status command	
3	POR	0: no POR since status 1 clear 1: POR occurred This bit is cleared upon the Clear Status command	
2	Reserved	-	
1	Reserved	-	
0	CRC	1: checksum of the latest write transfer failed	

Table 12: Status Register

6.10 Constant Current Heater (0x306D, 0x3066)

The constant current heater serves various purposes:

- Sensor function test, switching on of heater at constant environmental conditions and adapted time constants for T and RH
 - · Temperature T rises
 - Humidity RH falls
- Faster removal of condensation on the sensor
- Avoid condensation for faster response time at highest humidity
 - Humidity sensor operation at a constant over-temperature of approx. 2-3° C
 - The actual temperature is measured by a second unheated sensor.

The advantage of the "constant current heater" is that the power introduced by the heater, and thus also the over-temperature of the sensor, only changes linearly with the supply voltage.



Switching on/off the heater:

Command	CMD Hex Code		
	MSB LSB		
Heater ON	0x30	0x6D	
Heater OFF	0.00	0x66	

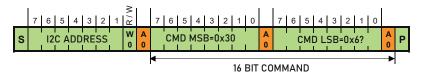


Figure 21: Constant current heater commands

At any kind of reset the heater gets deactivated automatically.

The value for the heater current is 5 mA.



Important note: The heater current must not lead to a temperature that exceeds the sensor's max. upper operational temperature limit.

6.11 CRC Calculation

Response data words/memory write data are protected by a CRC8 checksum:

Property	Value
Name	CRC8
Width	8 bit
Polynomial	0x31 (x8 + x5 + x4 + 1)
XOR input	0xFF
Reflect input	False
Reflect output	False
XOR output	0x00

Figure 22: CRC8 properties

6.12 Package / Dimensions

The HTE301 sensor is provided as an open-cavity DFN (= Dual Flat No Leads) package. The humidity sensor opening is centered on the top side of the package.

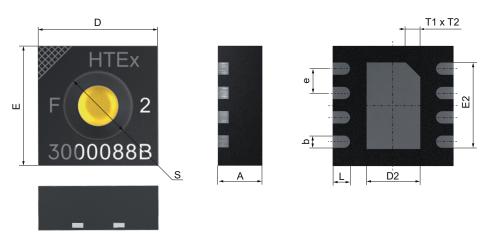


Figure 23: Package layout

PARAMETER	SYMBOL	MIN.	NOM.	MAX.	UNIT	COMMENT
Package width	D	2.40	2.50	2.60	mm	
Package length	E	2.40	2.50	2.60	mm	
Package height	Α	0.80	0.90	1.00	mm	
Cavity diameter	S		1.30		mm	On top of package
Leadframe height	A3		0.20		mm	Not shown in the drawing
Pad pitch	е		0.50		mm	
Pad width	b	0.20	0.25	0.30	mm	
Pad length	L	0.30	0.35	0.40	mm	
Thermal pad length	D2	1.00	1.10	1.20	mm	
Thermal pad width	E2	1.70	1.80	1.90	mm	
Thermal pad marking	T1xT2		0.30 x 0.30		mm	Indicates pin 1

Table 13: Package dimensions

6.13 Tape and Reel Packaging

The HTE301 has a Moisture Sensitivity Level (MSL) of 1, according to IPC/JEDEC J-STD-020. At the same time, it is recommended to further process the sensors within 1 year after date of delivery.

Dimensions T&R in mm:

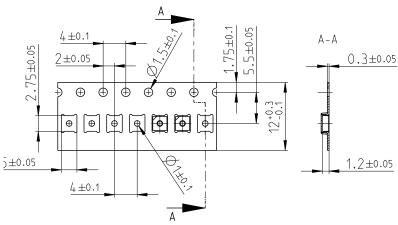


Figure 24: Tape layout



Reel size 330.2 mm (13"), Leader 520 mm (20.5"), Trailer 1240 mm (48.8").

Orientation on the tape:

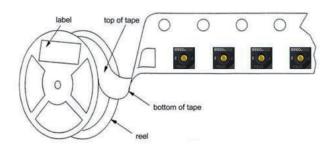


Figure 25: Orientation on the tape

6.14 Traceability

The laser marking upon the sensor's top side can be used for sensor identification / traceability.



A triangular mark at the top left indicates pin 1.

The upper line represents the designation of the component and consists of up to 6 characters. The "x" is a placeholder for the exact type, e.g. 301.

The remaining characters are a tracking code and are used by the manufacturer for identification.

Figure 26: HTEx laser marking

6.15 Ordering Information

TYPE		TAPE AND REEL PACK	AGING
HTE301	HTE301	2500 sensors	TR2,5
HTE301	HTE301	Cut tape	TRCT

Ordering example:

HTE301-TR2,5

Type: HTE301 Packaging: 2500 sensors

6.16 Recommended Layout

Recommended Land Pattern

2.5

Recommended Stencil Aperture

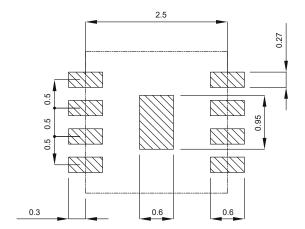


Figure 27: Recommended land pattern and stencil aperture

7 Quality

The HTEx qualification is performed based on the JEDEC JESD47 qualification test method. The device is fully RoHs and WEEE compliant.

8 Additional Documentation

DOCUMENT	DESCRIPTION	LINK
HTE301 Handling Instructions		www.epluse.com/hte301
HTE301 CRC8 Code Example	Code samples for Arduino and Raspberry PI	https://github.com/EplusE

Table 14: Applicable documentation

9 Revision History

DATE	VERSION	PAGE(S)	CHANGES
June 2022	1.0	1-23	Initial release

Table 15: Revision history